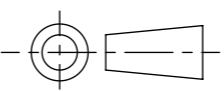



ITEM NO.	PART NUMBER	DESCRIPTION	QTY.
1	iW-PRFAZ-01-MD-R2.0-REL1.0-HEATSINK	HEATSINK	1
2	TG6050-TIM-48x15-1.0	THERMAL PAD 1.0MM	1
3	TG6050-TIM-35x35-1.0	THERMAL PAD 1.0MM	1
4	TG6050-TIM-32.5x14.4-3.0	THERMAL PAD 3 MM	1
5	TG6050-TIM-6.6x6.2-3.0	THERMAL PAD 3.0 MM	1
6	LABEL-30X10	LABEL	1
7	SCREW BAG	M3X 12 PAN HEAD SCREW WITH M3 NUT	4

THRMAL PAD PART NUMBER
TG6050-150-150-XX
XX-THICKNESS

NOTES:
 ALL DIMENSIONS ARE IN MM.
 ROUND OFF ALL SHARP EDGES.
 SCALE:

GENARALTOLERANCES :
 X: ± 0.25
 .X: ± 0.1
 .XX: ± 0.01



DRAWN BY	GANGADHAR	 iWave System Technologies Private Limited, 7/B, 29th Main, BTM Layout, 2nd Stage, Bangalore-560076, India.
CHECKED BY	GANGADHAR	
APPROVED BY	IMMANUEL	DRAWING NO: iW-HSKALU-CLASLR-CU02
THIS DRAWING SHEET IS PROPERITORY OF iWAVE SYSTEMS TECHNOLOGIES Pvt. Ltd.		MATERIAL : ----
		WEIGHT: ---- In grams.
		FINISH : ----
		SUR AREA: ---- In sqr.mm
		TITLE: HEAT SINK ASSEMBLY
		REV: 1.0 REL: 1.0
		DATE : 27/08/2019
		SHEET 1 OF 1

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